

TLP290-4

1. Applications

- Programmable Logic Controllers (PLCs)
- Switching Power Supplies
- Simplex/Multiplex Data Transmission

2. General

The Toshiba TLP290-4 consists of phototransistors optically coupled to gallium arsenide infrared emitting diodes. The TLP290-4 Photocoupler is housed in the very small and thin SO16 package.

Since the TLP290-4 is guaranteed over a wide operating temperature range ($T_a = -55$ to 110 °C), it is suitable for high-density surface mount applications such as programmable controllers.

3. Features

- (1) Collector-emitter voltage: 80 V (min)
- (2) Current transfer ratio: 50 % (min)
GB Rank: 100 % (min)
- (3) Isolation voltage: 2500 Vrms (min)
- (4) Operating temperature: -55 to 110 °C
- (5) Safety standards

UL-approved: UL1577, File No.E67349

cUL-approved: CSA Component Acceptance Service No.5A File No.E67349

VDE-approved: EN60747-5-5 (**Note 1**)

CQC-approved: GB4943.1, GB8898 Thailand Factory



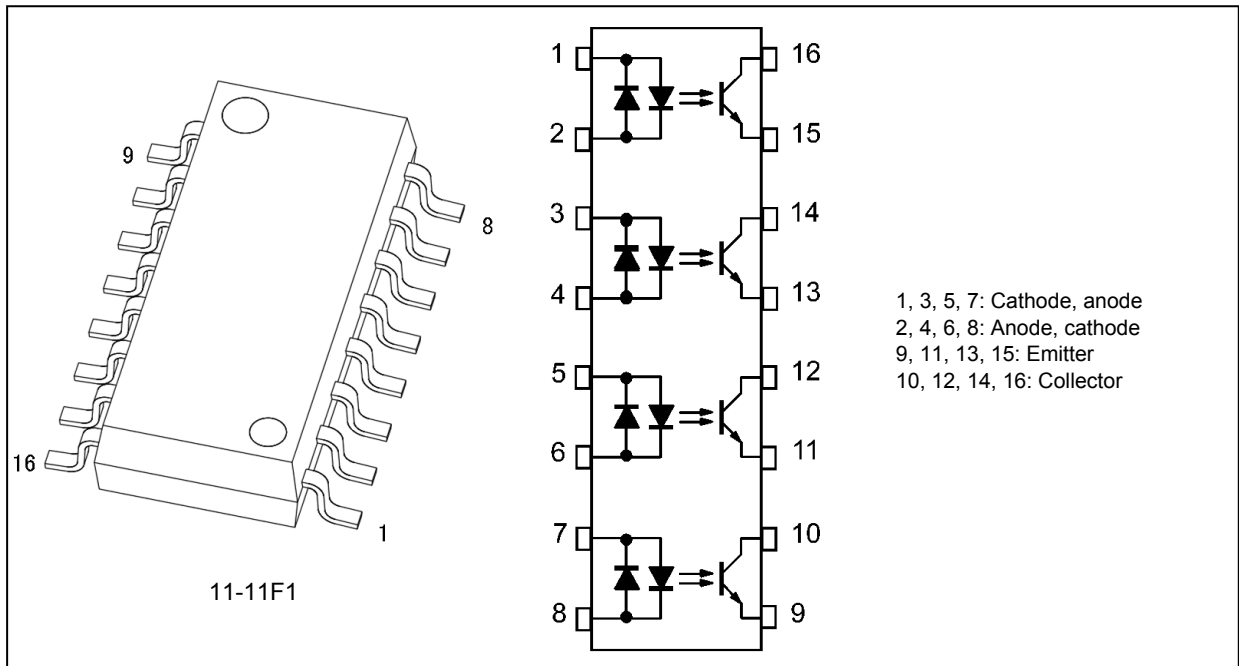
仅适用于海拔 2000m 以下地区安全使用

Note 1: When an EN60747-5-5 approved type is needed, please designate the **Option (V4)**.

Start of commercial production

2012-03

4. Packaging and Pin Configuration



5. Principle of Operation

5.1. Mechanical Parameters

Characteristics	Min	Unit
Creepage distances	5.0	mm
Clearance	5.0	
Internal isolation thickness	0.1	

6. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

	Characteristics	Symbol	Note	Rating	Unit
LED	R.M.S. forward current	I _{F(RMS)}		±50	mA
	Input forward current derating (T _a ≥ 50 °C)	ΔI _F /ΔT _a		-0.67	mA/°C
	Input forward current (pulsed)	I _{FP}	(Note 1)	±1	A
	Input power dissipation	P _D		70	mW
	Input power dissipation derating (1 circuit) (T _a ≥ 50 °C)	ΔP _D /ΔT _a		-0.93	mW/°C
	Junction temperature	T _j		125	°C
Detector	Collector-emitter voltage	V _{CEO}		80	V
	Emitter-collector voltage	V _{ECO}		7	
	Collector current	I _C		50	mA
	Collector power dissipation	P _C		100	mW
	Collector power dissipation derating (1 circuit) (T _a ≥ 25 °C)	ΔP _C /ΔT _a		-1.0	mW/°C
	Junction temperature	T _j		125	°C
Common	Operating temperature	T _{opr}		-55 to 110	°C
	Storage temperature	T _{stg}		-55 to 125	
	Lead soldering temperature (10 s)	T _{sol}		260	
	Total power dissipation (1 circuit)	P _T		170	mW
	Isolation voltage AC, 60 s, R.H. ≤ 60 %	BV _S	(Note 2)	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Pulse width (PW) ≤ 100 μs, f = 100 Hz

Note 2: This device is considered as a two-terminal device: All pins on the LED side are shorted together, and all pin on the photodetector side are shorted together.

7. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

	Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
LED	Input forward voltage	V _F		I _F = ±10 mA	1.1	1.20	1.4	V
	Input capacitance	C _t		V = 0 V, f = 1 MHz	—	30	—	pF
Detector	Collector-emitter breakdown voltage	V _{(BR)CEO}		I _C = 0.5 mA	80	—	—	V
	Emitter-collector breakdown voltage	V _{(BR)ECO}		I _E = 0.1 mA	7	—	—	
	Dark Current	I _{DARK}		V _{CE} = 48 V	—	0.01	0.1	μA
					V _{CE} = 48 V, T _a = 85 °C	—	2	
	Collector-emitter capacitance	C _{CE}		V = 0 V, f = 1 MHz	—	10	—	pF

8. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	I_C/I_F	(Note 1)	$I_F = \pm 5\text{ mA}, V_{CE} = 5\text{ V}$	50	—	400	%
			$I_F = \pm 5\text{ mA}, V_{CE} = 5\text{ V}, \text{Rank GB}$	100	—	400	
Saturated current transfer ratio	$I_C/I_{F(\text{sat})}$		$I_F = \pm 1\text{ mA}, V_{CE} = 0.4\text{ V}$	—	60	—	
			$I_F = \pm 1\text{ mA}, V_{CE} = 0.4\text{ V}, \text{Rank GB}$	30	—	—	
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		$I_C = 2.4\text{ mA}, I_F = \pm 8\text{ mA}$	—	—	0.4	V
			$I_C = 0.2\text{ mA}, I_F = \pm 1\text{ mA}$	—	0.2	—	
			$I_C = 0.2\text{ mA}, I_F = \pm 1\text{ mA}, \text{Rank GB}$	—	—	0.4	
OFF-state collector current	$I_{C(\text{off})}$		$V_F = \pm 0.7\text{ V}, V_{CE} = 48\text{ V}$	—	—	10	μA
Collector current ratio	$I_C(\text{ratio})$		See Fig. 8.1. $I_C(I_F = -5\text{ mA})/ I_C(I_F = 5\text{ mA})$	0.33	—	3	—

Note 1: See Table 8.1 for current transfer ratio.

Table 8.1 Current transfer ratio (CTR) Rank (Note) (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Rank	Test Condition	Current transfer ratio I_C/I_F Min	Current transfer ratio I_C/I_F Max	Marking of Classification	Unit
Blank	$I_F = \pm 5\text{ mA}, V_{CE} = 5\text{ V}$	50	400	Blank	%
GB		100	400	GB	

Note: Specify both the part number and a rank in this format when ordering.

Example: TLP290-4 (GB,E)

For safety standard certification, however, specify the part number alone.

Example: TLP290-4 (GB,E: TLP290-4)

$$I_C(\text{ratio}) = \frac{I_{C2}(I_F = I_{F2}, V_{CE} = 5\text{ V})}{I_{C1}(I_F = I_{F1}, V_{CE} = 5\text{ V})}$$

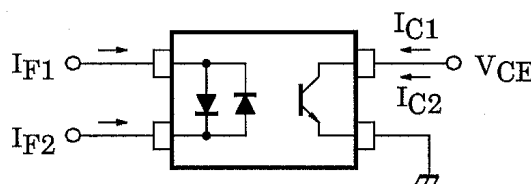


Fig. 8.1 Collector Current Ratio Test Circuit

9. Isolation Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Note	Test Conditions	Min	Typ.	Max	Unit
Total capacitance (input to output)	C_S		$V_S = 0\text{ V}$, $f = 1\text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S		$V_S = 500\text{ V}$, R.H. $\leq 60\%$	1×10^{12}	10^{14}	—	Ω
Isolation voltage	BV_S	(Note1)	AC, 60 s	2500	—	—	Vrms
			AC, 1 s in oil	—	5000	—	
			DC, 60 s in oil	—	5000	—	Vdc

Note1: This device is considered as a two-terminal device: All pins on the LED side are shorted together, and all pin on the photodetector side are shorted together.

10. Switching Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Rise time	t_r		$V_{CC} = 10\text{ V}$, $I_C = 2\text{ mA}$, $R_L = 100\ \Omega$	—	2	—	μs
Fall time	t_f			—	3	—	
Turn-on time	t_{on}			—	3	—	
Turn-off time	t_{off}			—	3	—	
Turn-on time	t_{on}		See Figure 10.1	—	2	—	
Storage time	t_s		$R_L = 1.9\text{ k}\Omega$, $V_{CC} = 5\text{ V}$, $I_F = 16\text{ mA}$	—	25	—	
Turn-off time	t_{off}			—	60	—	

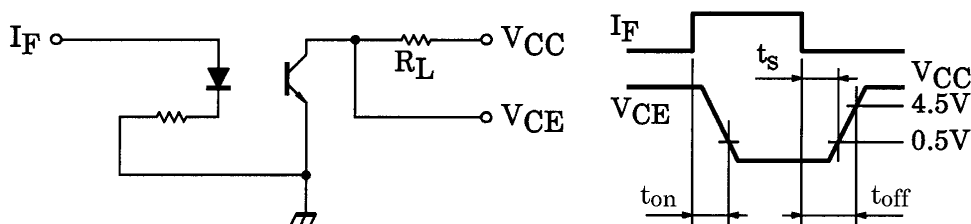


Fig. 10.1 Switching Time Test Circuit and Waveform

11. Characteristics Curves (Note)

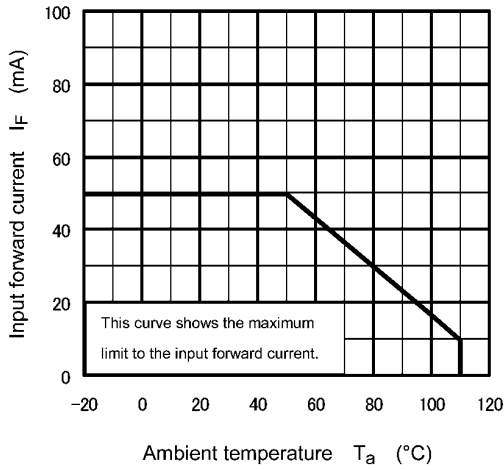


Fig. 11.1 $I_F - T_a$

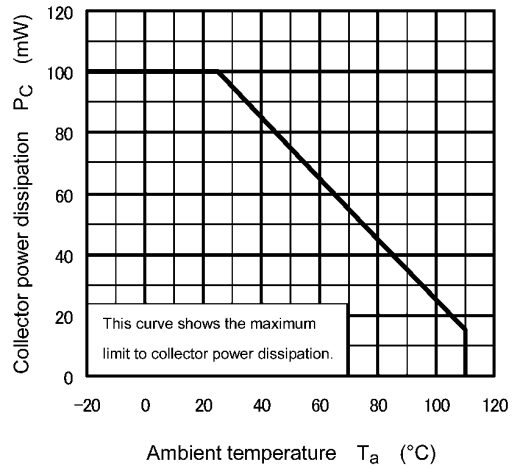


Fig. 11.2 $P_C - T_a$

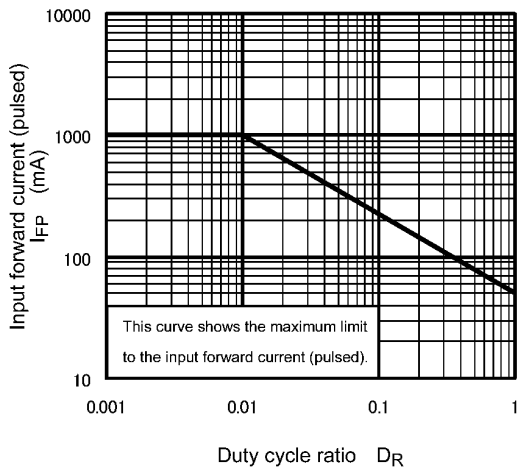


Fig. 11.3 $I_{FP} - D_R$

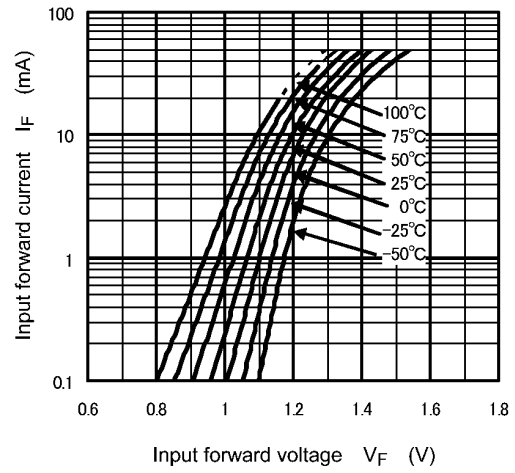


Fig. 11.4 $I_F - V_F$

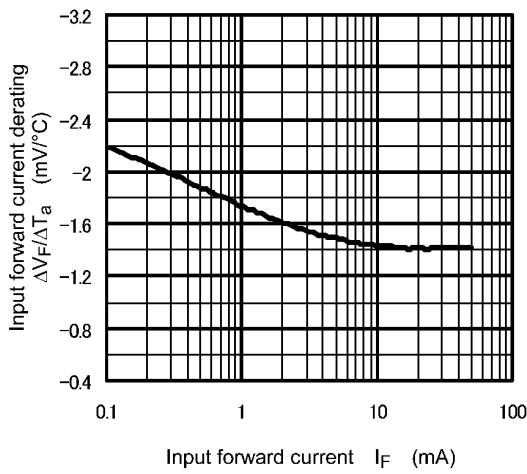


Fig. 11.5 $\Delta V_F/\Delta T_a - I_F$

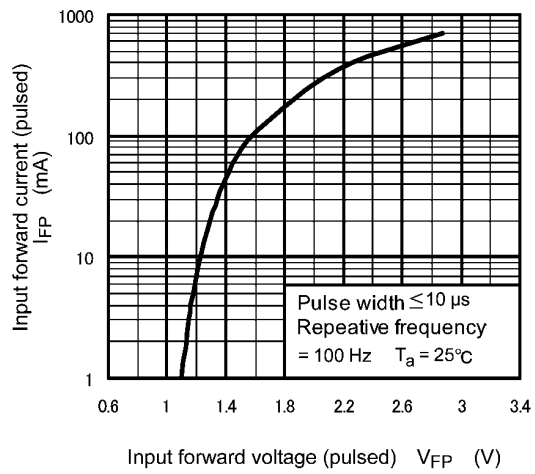


Fig. 11.6 $I_{FP} - V_{FP}$

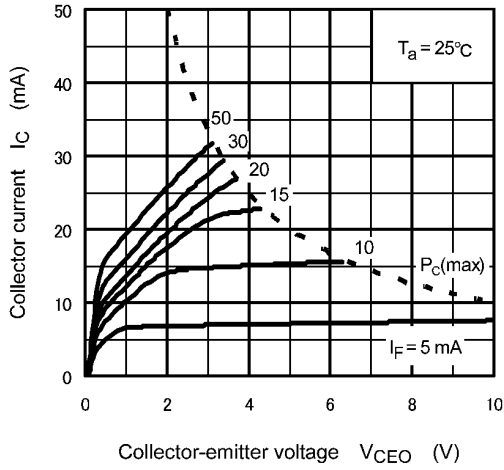


Fig. 11.7 $I_C - V_{CE0}$

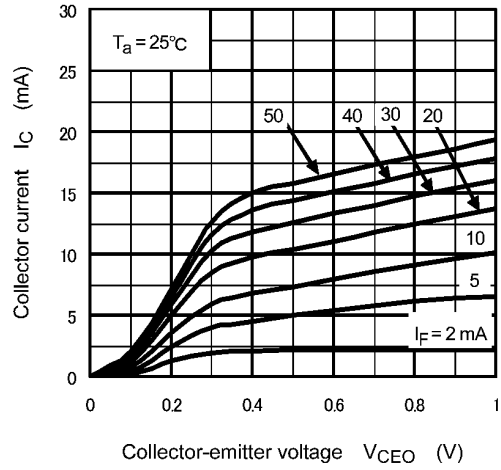


Fig. 11.8 $I_C - V_{CE0}$

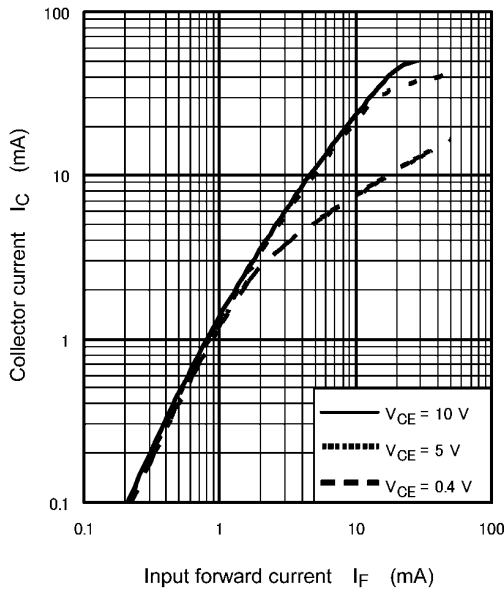


Fig. 11.9 $I_C - I_F$

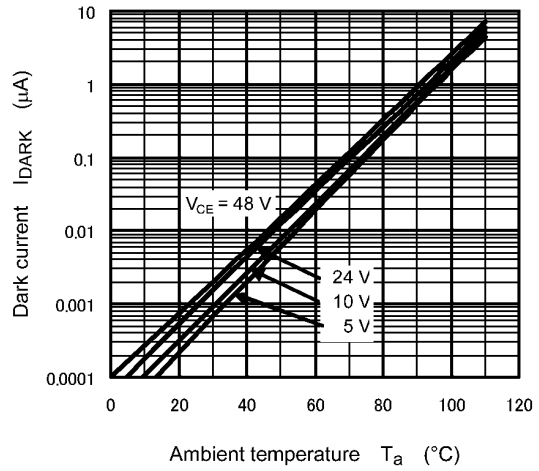


Fig. 11.10 $I_{DARK} - T_a$

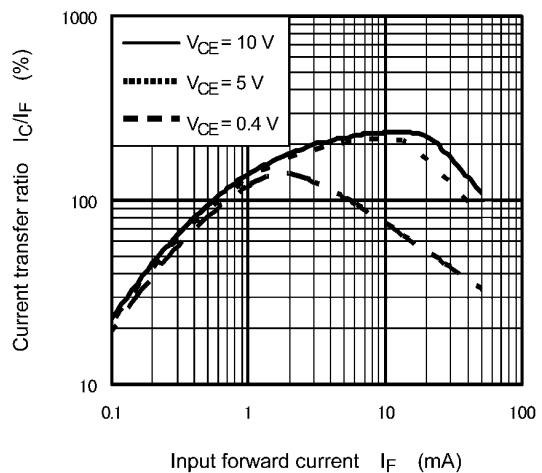


Fig. 11.11 $I_C/I_F - I_F$

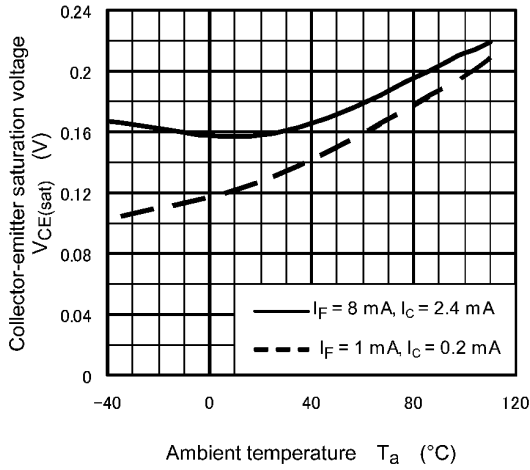


Fig. 11.12 $V_{CE(sat)} - T_a$

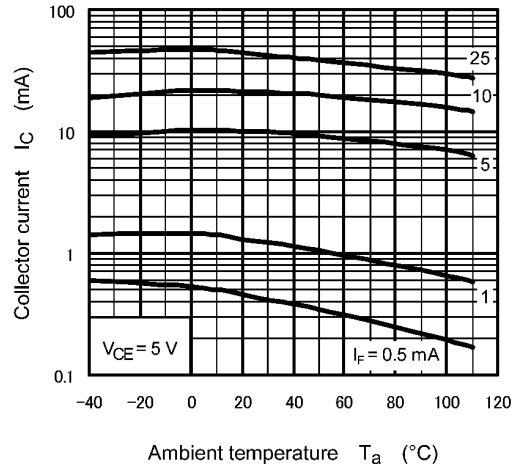


Fig. 11.13 $I_C - T_a$

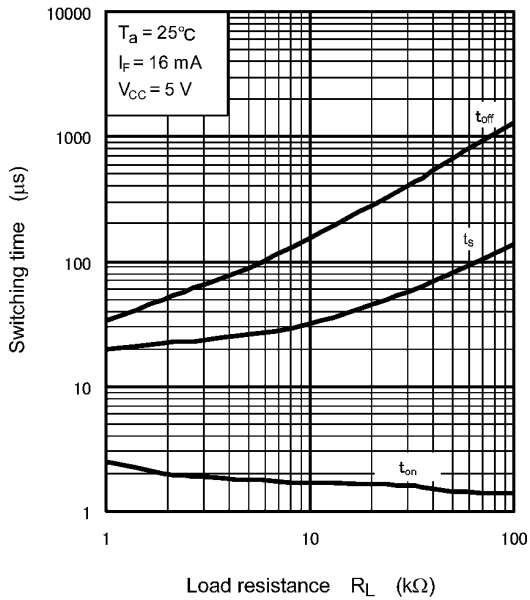


Fig. 11.14 Switching Time - R_L

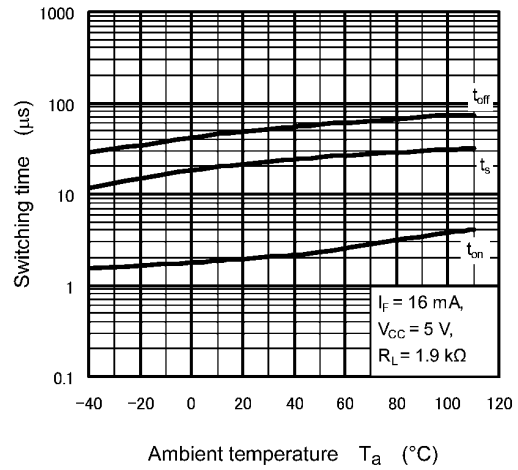


Fig. 11.15 Switching Time - T_a

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

12. Soldering and Storage

12.1. Precautions for Soldering

The soldering temperature should be controlled as closely as possible to the conditions shown below, irrespective of whether a soldering iron or a reflow soldering method is used.

- When using soldering reflow.

The soldering temperature profile is based on the package surface temperature.

(See the figure shown below, which is based on the package surface temperature.)

Reflow soldering must be performed once or twice.

The mounting should be completed with the interval from the first to the last mountings being 2 weeks.

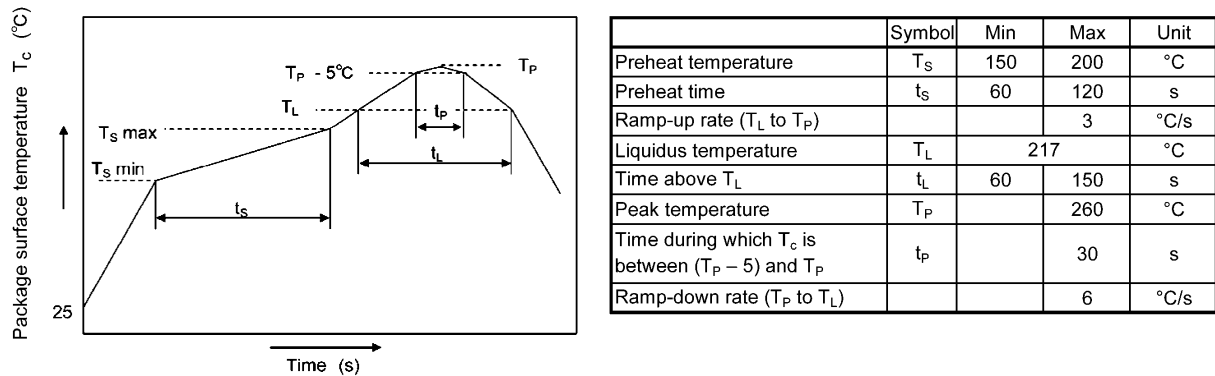


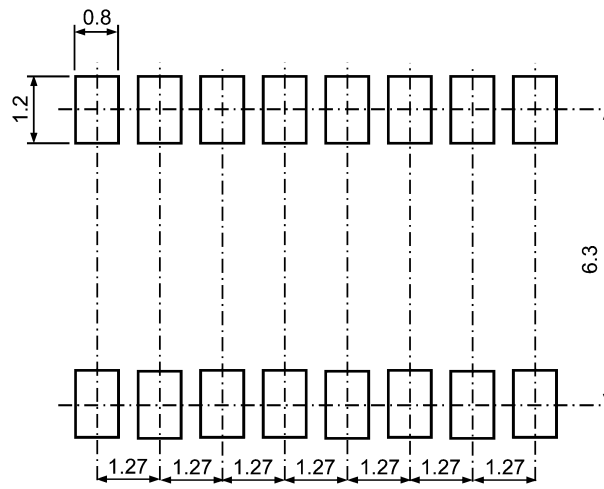
Fig. 12.1.1 An example of a temperature profile when lead(Pb)-free solder is used

- When using soldering flow
Preheat the device at a temperature of 150 °C (package surface temperature) for 60 to 120 seconds.
Mounting condition of 260 °C within 10 seconds is recommended.
Flow soldering must be performed once.
- When using soldering Iron
Complete soldering within 10 seconds for lead temperature not exceeding 260 °C or within 3 seconds not exceeding 350 °C
Heating by soldering iron must be done only once per lead.

12.2. Precautions for General Storage

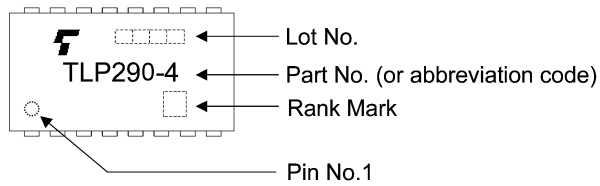
- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5°C to 35°C and 45% to 75%, respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- When restoring devices after removal from their packing, use anti-static containers.
- Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

13. Land Pattern Dimensions for Reference Only



Unit: mm

14. Marking



15. Embossed-Tape Packing (TP) Specification for Mini-Flat Photocouplers

15.1. Applicable Package

Package Name	Product Type
SO16	Mini-Flat Coupler

15.2. Product Naming Conventions

Type of package used for shipment is denoted by a symbol suffix after a part number. The method of classification is as below.

Example) TLP290-4 (GB-TP, E

Part number: TLP290-4

CTR rank: (GB

Tape type: TP

[[G]]/RoHS COMPATIBLE: E (Note)

Note: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

15.3. Tape Dimensions Specification

15.3.1. Orientation of Device in Relation to Direction of Feed

Device orientation in the carrier cavities as shown in Figure 15.3.1.1.

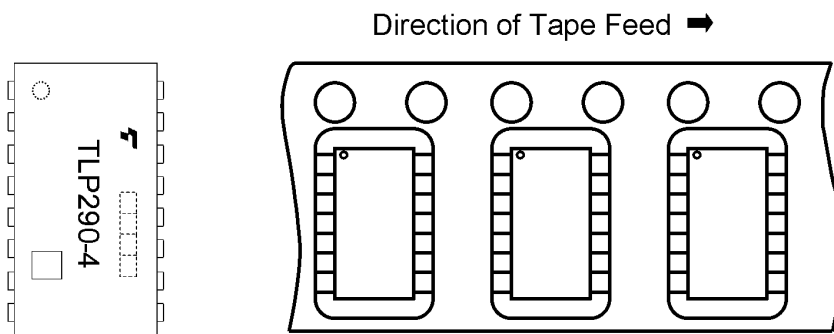


Fig. 15.3.1.1 Device Orientation

15.3.2. Packing Quantity

2000 pcs per reel

15.3.3. Empty Cavities

Table 15.3.3.1 Empty Cavities

Characteristics	Criterion	Remarks
Occurrences of 2 or more successive empty cavities	0	Within any given 40-mm section of tape, not including leader and trailer
Single empty cavity	6 devices (max) per reel	Not including leader and trailer

15.3.4. Tape Leader and Trailer

The start end of the tape has 50 or more empty cavities. The hub end of the tape has 50 or more empty cavities and two empty turns only for a cover tape.

15.3.5. Tape Dimensions

Tape material: Plastic (for protection against static electricity)

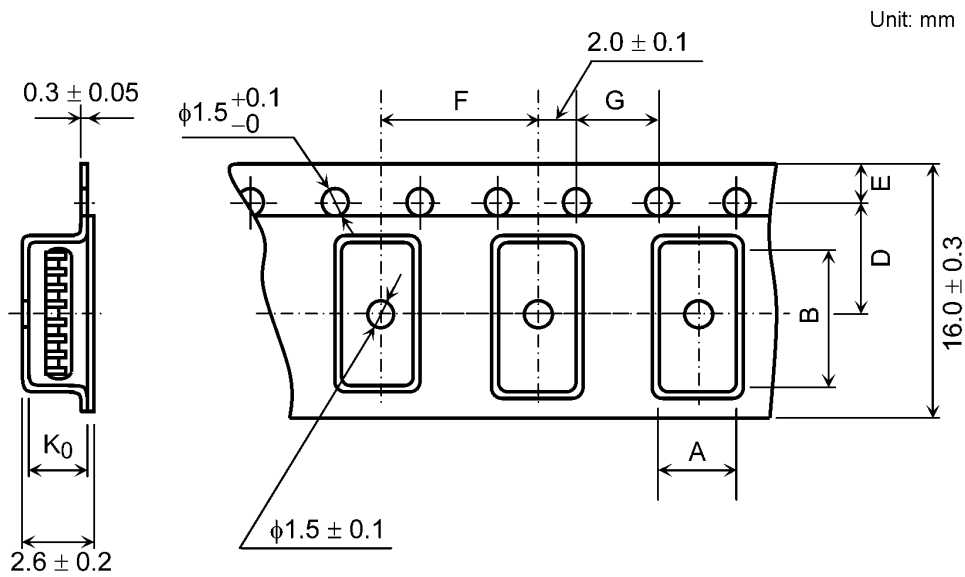


Fig. 15.3.5.1 Tape Dimensions

Table 15.3.5.1 Tape Dimensions (unit: mm, unless otherwise specified: ±0.1)

Symbol	Dimension	Remark
A	7.5	—
B	10.5	—
D	7.5	Center line of embossed cavity and sprocket hole
E	1.75	Distance between tape edge and sprocket hole center
F	12.0	Cumulative error +0.1/-0.3 (max) per 10 empty cavities holes
G	4.0	Cumulative error +0.1/-0.3 (max) per 10 sprocket holes
K ₀	2.2	Internal space

15.3.6. Reel specification

Material: Plastic

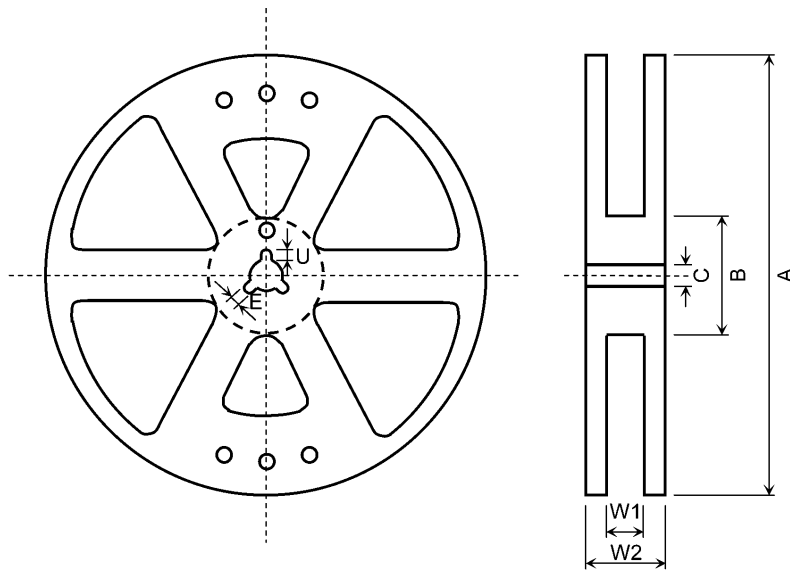


Fig. 15.3.6.1 Reel Dimensions

**Table 15.3.6.1
Reel Dimensions (unit: mm)**

Symbol	Dimension
A	$\phi 330 \pm 2$
B	$\phi 80 \pm 1$ or $\phi 100 \pm 1$
C	$\phi 13 \pm 0.5$
E	2.0 ± 0.5
U	4.0 ± 0.5
W1	17.5 ± 0.5
W2	21.5 ± 1.0

15.4. Packing

Either one reel or ten reels of photocouplers are packed in a shipping carton.

15.5. Label Format

- (1) Carton: The label provides the part number, quantity, lot number, the Toshiba logo, etc.
- (2) Reel: The label provides the part number, the taping name, quantity, lot number, etc.

15.6. Ordering Information

When placing an order, please specify the part number, CTR rank, tape type and quantity as shown in the following example.

Example) TLP290-4 (GB-TP, E 2000)

Part number: TLP290-4

CTR rank: (GB

Tape type: TP

[[G]]/RoHS COMPATIBLE: E (**Note**)

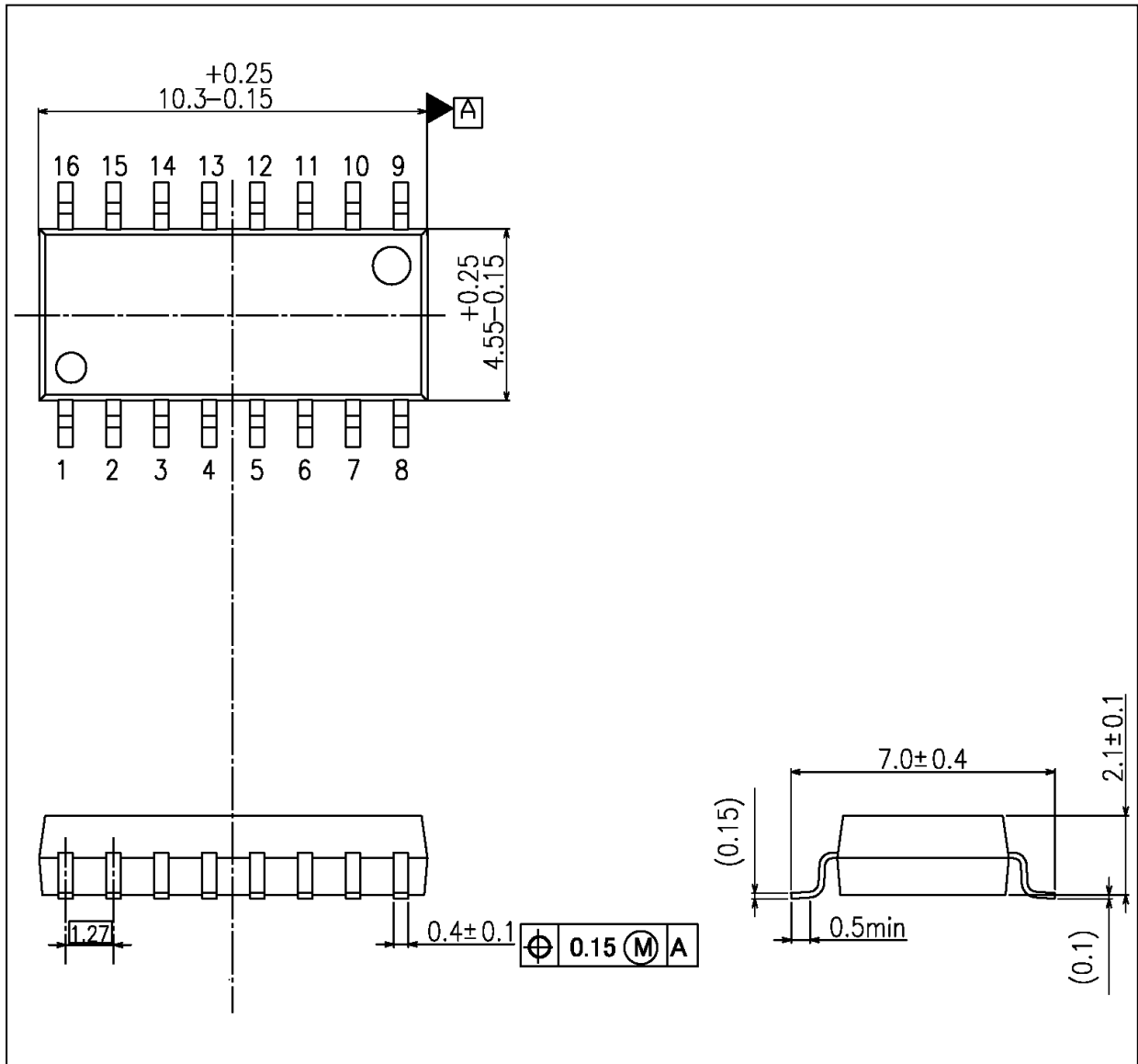
Quantity (must be a multiple of 2000)

Note: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment.

Package Dimensions

Unit: mm



Weight: 0.19 g (typ.)

Package Name(s)
TOSHIBA: 11-11F1

RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. **TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.**
- **PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE").** Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. **IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT.** For details, please contact your TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- **ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.**
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. **TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.**

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Toshiba manufacturer](#):

Other Similar products are found below :

[TLP624-4F](#) [HDEPR01GEA51](#) [TB62218AFTG,8,EL](#) [TB6560AHQ\(O,8\)](#) [TORX1952\(6M,F\)](#) [TB62215AFTG,8,EL](#) [TC7SH02FU,LJ](#)
[TC7WT125FU\(TE12L,F](#) [2SA1587-BL,LF](#) [TC7SBL384CFU,LF](#) [TK20V60W,LVQ](#) [TLP183\(GB,E](#) [431392HB](#) [EMPP008Z](#)
[TC58DVM92A5TA00](#) [TLP291\(TP,E\)](#) [TLP5214\(D4-TP,E](#) [TLP591B\(C,F\)](#) [TPC8120](#) [TLP352\(LF1,F\)](#) [TLP206A\(F\)](#) [TLP109\(TPR,E\)](#)
[TK16A60W,S4VX](#) [TC4013BP\(N,F](#) [TBD62503AFNG,EL](#) [TCK112G,LF](#) [TLP185\(GR-TPL,E\(O](#) [TLP185\(GB-TPR,E\(O](#) [TLP3906\(TPR,E\(O](#)
[VFNC3S-2002PL](#) [VFNC3S-2015PL](#) [TLP7820\(D4-A,E](#) [SSM3J35AMFV,L3F](#) [SSM3J14T](#) [TCK22971G,LF](#) [THGBMDG5D1LBAIL](#)
[TLP3214\(TP15,F\)](#) [058399HB](#) [TORX177F,T](#) [TLP190B\(U,C,F\)](#) [VFS15S-2015PL-W](#) [TB6560AFG,8](#) [TK39N60W5,S1VF](#) [TLP5754\(D4,E](#)
[TC7W14FUTE12LF](#) [AB3X2X3W](#) [TB6560AFG\(O,8\)](#) [TB6568KQ\(O,8\)](#) [TLP185\(GR.E\(O](#) [74HC138D](#)